

Product Change Notification

Related products: MFP 161 D
MFP 261 N, MFP 261 N-RA, MFP 261 N-RA 4,5
MFP 263 P, MFP 263 P-RA
MFP 461 N, MFP 461 N 2MM, MFP 461 N-GRU
MFP 461 N-RA, MFP 461 P-RA
MFP 661 N

Effective Date: immediately, valid also for already shipped components

Details:

Based on JEDEC JSTD-075, the process capability is specified more detailed.

According to JSTD 075 it is:

Classification W4Y

Pre-heat max. 100°C/60s

Time in wave max. 5s

Temperature on solder side of the PCB max. 260°C

Only one pass

No liquid cleaning

There is no modification of the components, this notification concerns only the specification.

knitter-switch, Mai 2009



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